IN THE SPECIFICATION

(23(6)(1) In the cross-reference to related applications, please amend such paragraph by adding the following sentence to the end of such cross-reference – There is another application which is related to and claims priority from U.S. Patent Application Serial No. 09/366,685 and is co-pending as Serial No. 09/775,106.

IN THE CLAIMS

- (Amended) A method of ablating or changing properties in structure of non-biologic materials-laser induced breakdown with a pulsed laser beam, said method comprising the steps of: generating a beam of one or more laser pulses characterized by a pulse width with a relationship of fluence breakdown threshold versus laser pulse width having a distinct change in slope, having a pulse width approximately equal to or less than a pulse width at which laser induced breakdown becomes essentially accurate; and directing said beam to the material.
- 47. (Amended) A method of ablation or changing properties in structure of non-biologic materials laser induced breakdown in a volume characterized by a maximum dimension with a pulsed laser beam comprising: generating a pulsed laser beam characterized by a pulse width with a relationship of fluence breakdown threshold versus laser pulse width having a distinct change in slope, characterized by a wavelength of operation that is greater than said dimension; and directing said beam to the material.

46.

48. (Amended) A method of ablation or changing properties in structure of non-biologic materials with a pulsed laser beam comprising:

generating a pulsed laser beam characterized by a pulse width with a relationship of fluence breakdown threshold versus laser pulse width having a distinct change in slope, having at least one pulse with a pulse width sufficiently short that the size of the feature created in the material is not substantially limited by thermal diffusion in the material; and directing said beam to the material.

- 49. (Amended) A method of ablation or changing properties in structure of non-biologic materials characterized by a thermal diffusivity, D, with a pulsed laser beam having a pulse width, T, characterized by a pulse width with a relationship of fluence breakdown threshold versus laser pulse width having a distinct change in slope, said method comprising the steps of:
- generating a beam of one or more laser pulses having a pulse width sufficiently short so that the thermal diffusion length I_{th}=Dt^{1/2} in the material is significantly smaller than the absorption depth (1/a), where a is the absorption coefficient for the radiation; and directing said beam to the material.
- 50. (Amended) A method of ablation or changing properties in structure of non-biologic materials with a pulsed laser beam characterized by a beam shape and a fluence and a pulse width with a relationship of fluence breakdown threshold versus laser pulse width having a distinct change in slope, comprising, generating a beam

BI

having at least one pulse with a pulse width sufficiently short so that the affected area is substantially determined solely by the beam shape and fluence in relation to the threshold for laser induced breakdown; and directing said beam to the material.

- 53. (Amended) The method according to claim 52 wherein the material comprises at least two layers and laser induced breakdown substantially affects one layer and not the other.
 - 54. (Amended) The method of claim 53 wherein the material comprises a layer of metal on glass and laser induced breakdown is induced in the layer of metal.
 - 55. (Amended) The method of any of claims 46-50 wherein laser induced breakdown is induced on the surface of the material.
 - 56. (Amended) The method of any of claims 46-50 wherein laser induced breakdown is induced beneath the surface of the material.
- 61. (Amended) The method of claim 56 in which laser induced breakdown causes thermal-physical changes in state leading to an irreversible change in the material.

BY

63. (Amended) The method of any of claims 46-50 in which laser induced breakdown includes changes caused by one or more of ionization, free electron multiplication, dielectric breakdown, plasma formation, and vaporization.

BS

- 67. (Amended) The method according to any of claims 46-50 comprising scanning the beam along a predetermined path beneath the surface of the material to induce laser induced breakdown therein to a depth smaller than the Rayleigh range.
- 68. (Amended) The method according to any of claims 46-50 comprising laser induced breakdown of a material used in one of micromachining, integrated circuit manufacture and encoding data in data storage media.
- 69. (Amended) The method according to any of claims 46-50 comprising laser induced breakdown in a spot without adversely affecting peripheral areas adjacent to the spot.

131

78. (Amended) A method for laser induced breakdown of a non-biological opaque or transparent material with a pulsed laser beam, the material being characterized by a relationship of fluence threshold at which breakdown occurs versus laser pulse width that exhibits a distinct change in slope at a characteristic laser pulse width, said method comprising the steps of:

generating at least one laser pulse which has a pulse width equal to or less than said characteristic laser pulse width; and

directing said pulse to a point at or beneath the surface of the opaque or transparent material.

79. (Amended) A method for laser induced breakdown of a metal layer on a glass substrate with a pulsed laser beam, the metal being characterized by a relationship of fluence threshold at which breakdown occurs versus laser pulse width that exhibits a distinct change in slope at a characteristic laser pulse width, said method comprising the steps of:

generating at least one laser pulse which has a pulse width equal to or less than said characteristic laser pulse width; and

directing said pulse to a point at or beneath the surface of the metal.

80. (Amended) A method for laser induced breakdown of a first layer of non-biologic material on another layer of non biological material with a pulsed laser beam, without substantially affecting the first layer, the first layer being characterized by a relationship of fluence threshold at which breakdown occurs versus laser pulse width that exhibits a distinct change in slope at a characteristic laser pulse width, said method comprising the steps of:

generating at least one laser pulse which has a pulse width equal to or less than said characteristic laser pulse width; and

directing said pulse to a point at or beneath the surface of the first layer.